

## Declaration and Power of Attorney for a Patent Application

### Declaration

As below named inventor, I hereby declare that my residence post office address, and citizenship are as stated below my name. Further, I hereby declare that I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

### PSEUDO-RANDOM n-OUT-of-N PACKET SAMPLING

the specification of which:

  X   is attached hereto, or  
           was filed on                                  as application serial no.                                  : and  
           was amended on                                 

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above; and

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

### Foreign Priority Claim

I hereby claim foreign priority benefits under Title 35, United States Code Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

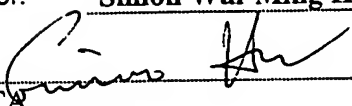
Number	Country	Date Filed	Priority Claimed
<u>                                </u>	<u>                                </u>	<u>                                </u>	<u>          </u> yes <u>          </u> no
<u>                                </u>	<u>                                </u>	<u>                                </u>	<u>          </u> yes <u>          </u> no

### U.S. Priority Claim

I hereby claim the benefit under Title 35, United States Code, Section 120 and 199(e) of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Serial Number	Filing Date	Status (patented/pending/abandoned)
<u>                                </u>	<u>                                </u>	<u>                                </u>
<u>                                </u>	<u>                                </u>	<u>                                </u>

Full Name of Second Inventor: Simon Wai-Ming HSU

Inventor's Signature 

Date

1-21-04

Residence

San Mateo, CA

Citizenship

Canada

(City

State)

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